



HVBMS Centralized Cell Monitoring Unit Using ETPL with MC33775A (CMU)

RD33775ACNTEVB NEW

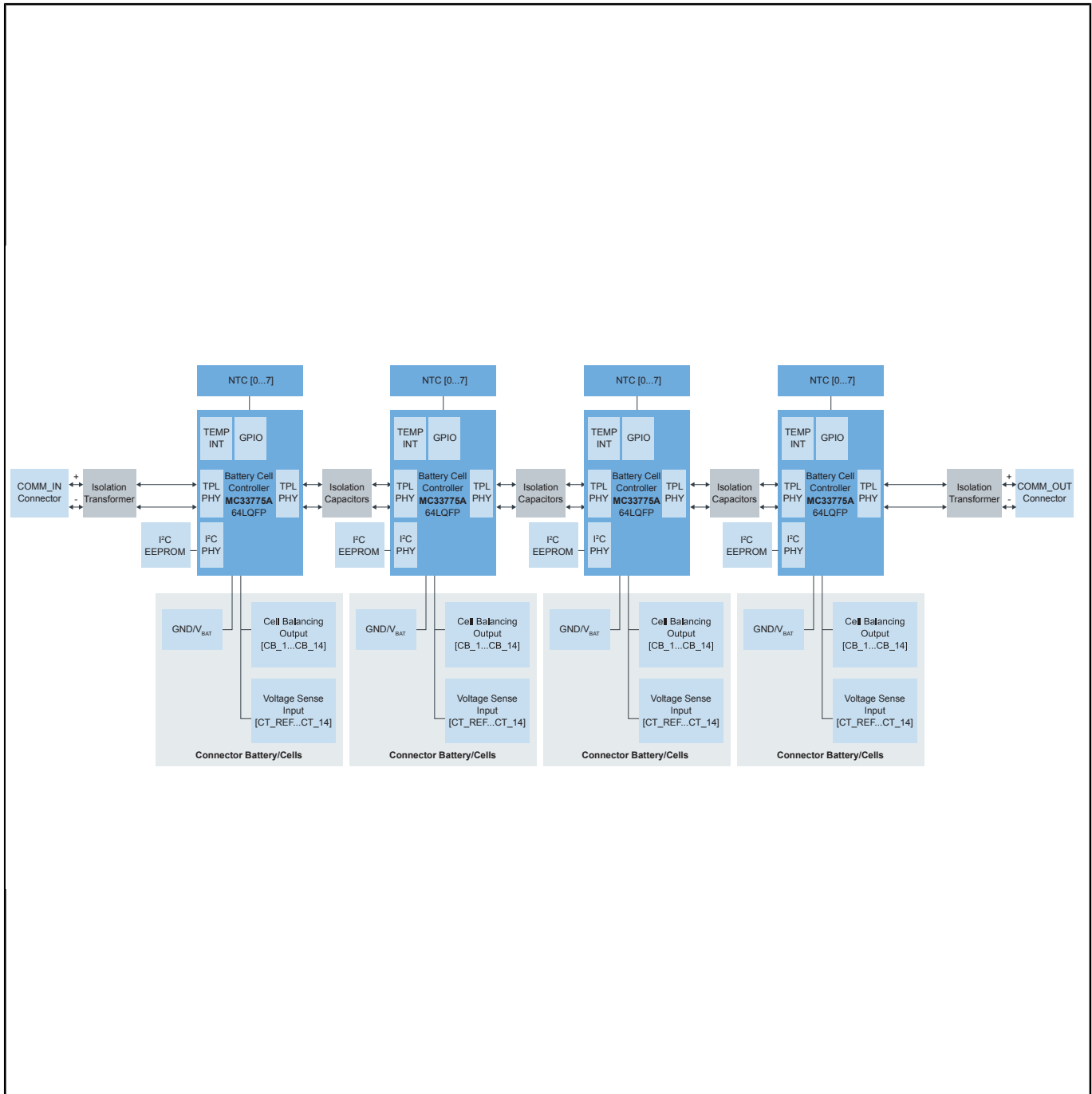
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The RD33775ACNTEVB is a centralized cell monitoring unit (CMU) reference design with electrical transport protocol link (ETPL) communication. It is ideal for rapid prototyping of a high-voltage battery management system (HVBMS) hardware and software. This board contains four MC33775A analog front ends (AFEs) in a daisy chain.

This board is part of the [RD-HVBMSCTBUN](#) HVBMS reference design bundle using ETPL.

HVBMS Centralized Cell Monitoring Unit Using ETPL with MC33775A - RD33775ACNTEVB Block Diagram



View additional information for [HVBMS Centralized Cell Monitoring Unit Using ETPL with MC33775A \(CMU\)](#).

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